



Index Notice

6 October 2025

Renaming and Methodology Change of the Hang Seng China A Semiconductors Index

The Hang Seng China A Semiconductors Index will be renamed to the **Hang Seng China Semiconductor Chips Index**. The index methodology will also be updated as follows:

- Modifying the objective and universe
- Modifying the constituent selection criteria and capping method
- Adding geographical requirements, the quarterly Fast Entry Rule, Southbound Stock Connect eligibility requirements, and a buffer zone
- Fixing the number of constituents at 40

These changes will be implemented in the index review for the period ending 30 June 2025. The index name change and the corresponding constituent changes will be effective on 15 October 2025 (Wednesday). The index vendor code will remain unchanged. Please refer to the Appendix for the corresponding index review results.

For full details, please refer to the latest methodology document [here](#).

For enquiries, contact us at: info@hsi.com.hk

End



Appendix 1

The following constituent changes will be made to the Hang Seng China Semiconductor Chips Index, effective on 15 October 2025 (Wednesday). The total number of constituents will decrease from 90 to 40.

Inclusion:

Code		Company
A Shares	HK Shares	
	981	Semiconductor Manufacturing International Corp.
	1347	Hua Hong Semiconductor Ltd.
	2577	InnoScience (Suzhou) Technology Holding Co., Ltd. - H Shares

Removal:

Code		Company
A Shares	HK Shares	
001309		Shenzhen Techwinsemi Technology Co., Ltd.
300077		Nations Technologies Inc.
300101		Chengdu Corp.ro Technology Co., Ltd.
300236		Shanghai Sinyang Semiconductor Materials Co., Ltd.
300346		Jiangsu Nata Opto-Electronic Material Co., Ltd.
300373		Yangzhou Yangjie Electronic Technology Co., Ltd.
300456		Sai Microelectronics Inc.
300458		All Winner Technology Co., Ltd.
300613		Shanghai Fullhan Microelectronics Co., Ltd.
300623		Jiangsu Jiejie Microelectronics Co., Ltd.
300666		Konfoong Materials Int. Co., Ltd.
300672		Hunan Goke Microelectronics Co., Ltd.
301095		Semitronix Corp.
301536		SigmaStar Technology Ltd.
301611		Suzhou Kematek, Inc.
600171		Shanghai Belling Corp., Ltd.
600206		Grinm Advanced Materials Co., Ltd.
600877		CETC Chips Technology Inc.
603005		China Wafer Level Csp Co., Ltd.
603290		Starpower Semiconductor Ltd.
605111		Wuxi Nce Power Co., Ltd.
605358		Hangzhou Lion Microelectronics Co., Ltd.
688018		Espressif Systems (Shanghai) Co., Ltd.
688019		Anji Microelectronics Technology (Shanghai) Co., Ltd.
688037		KINGSEMI Co., Ltd.
688052		Suzhou Novosense Microelectronics Co., Ltd.
688107		Shanghai Anlogic Infotech Co., Ltd.
688110		Dosilicon Co., Ltd.
688141		JoulWatt Technology Co., Ltd.
688153		Vanchip (Tianjin) Technology Co., Ltd.
688172		Beijing Yandong Micro Electronic Co., Ltd.
688200		Beijing Huafeng Test & Control Technology Co., Ltd.
688220		ASR Microelectronics Co., Ltd.
688234		SICC Co., Ltd.



688279		Fortior Technology(Shenzhen)Co., Ltd.
688347		Hua Hong Semiconductor Ltd.
688352		Hefei Chipmore Technology Co., Ltd.
688361		Skyverse Technology Co., Ltd.
688362		Forehope Electronic (Ningbo) Co., Ltd.
688409		Shenyang Fortune Precision Equipment Co., Ltd.
688432		Grinm Semiconductor Materials Co., Ltd.
688439		Guizhou Zhenhua Fengguang Semiconductor Co., Ltd.
688449		Maxio Technology (Hangzhou) Co., Ltd.
688484		Southchip Semiconductor Technology(Shanghai) Co., Ltd.
688498		Yuanjie Semiconductor Technology Co., Ltd.
688536		3Peak Incorporated
688582		Anhui Xdlk Microsystem Corp., Ltd.
688584		Wafer Works (Shanghai) Co., Ltd.
688605		Sprint Precision Technologies Co., Ltd.
688702		Suzhou Centec Communications Co., Ltd.
688709		Chengdu Sino - Microelectronics Tech. Co., Ltd.
688798		Shanghai Awinic Technology Co., Ltd.
688981		Semiconductor Manufacturing Int. Corp.